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Part Number: [0459110010](#)
Status: **Active**
Overview: [edge_card_connectors](#)
Description: 12.90mm (.508") Pitch EXTreme PowerEdge™, Mixed Power/Signal Card Edge Connector, Double Sided, 3 Segments (Signal, Power, Signal Sequence), Through Hole Solder for 2.36mm (.093") or 3.18mm (.125") Thick PC Board

Documents:
[3D Model](#) [Product Specification PS-45719-001 \(PDF\)](#)
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification

CSA	LR 19980
TUV	30482572.001
UL	E29179

General

Product Family	Edge Card Connectors
Series	45911
Component Type	Edgecard to PCB
Overview	edge_card_connectors
Product Name	EXTreme PowerEdge™

Physical

Circuits (Loaded)	18
Circuits (maximum)	18
Circuits Detail	8 Signal, 2 Power, 8 Signal
Color - Resin	Black
Durability (mating cycles max)	250
Entry Angle	Vertical (Top Entry)
Flammability	94V-0
Keying to Mating Part	N/A
Material - Metal	Phosphor Bronze
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
PC Tail Length (in)	0.182 In
PC Tail Length (mm)	4.63 mm
PCB Thickness Recommended (in)	0.093 In, 0.125 In
PCB Thickness Recommended (mm)	2.40 mm, 3.20 mm
Packaging Type	Tray
Pitch - Mating Interface (in)	0.508 In
Pitch - Mating Interface (mm)	12.90 mm
Plating min: Mating (µin)	30
Plating min: Mating (µm)	0.75
Plating min: Termination (µin)	150
Plating min: Termination (µm)	3.75
Temperature Range - Operating	-40°C to +105°C
Termination Interface: Style	Through Hole

Electrical

Current - Maximum per Contact	3A, 40A
Voltage - Maximum	250V

Solder Process Data

Duration at Max. Process Temperature (seconds)	5
Lead-free Process Capability	Wave Capable (TH only)



EU RoHS
ELV and RoHS
Compliant
REACH SVHC
Contains SVHC: No
Halogen-Free
Status
Halogen-Free

China RoHS



Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series
[45911Series](#)

Mates With
1.58mm (.062") double sided card edge

Max. Cycles at Max. Process Temperature	1
Process Temperature max. C	250

Material Info

Reference - Drawing Numbers

Packaging Specification	PK-45714-001
Product Specification	PS-45719-001
Sales Drawing	SD-45911-001

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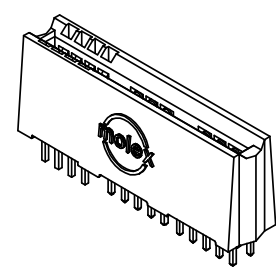


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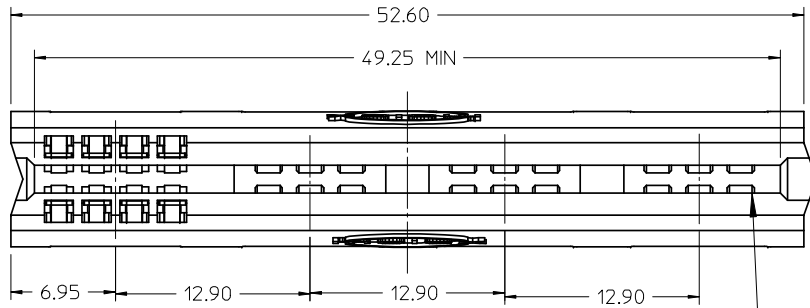
MATERIAL NUMBER: 45911-0007 SHOWN
SEE SHEET ONE FOR ALL OTHER NOTES AND DIMENSIONS



MATERIAL NUMBER	SEGMENT 3	SEGMENT 2	SEGMENT 1	$\frac{DIM P}{DIM T}$	PCB THK
45911-0007	SIGNAL	POWER	POWER	$\frac{4.50}{4.33}$	3.18 2.36
45911-0008	POWER	SIGNAL	POWER		
45911-0009	SIGNAL	SIGNAL	POWER		
45911-0010	SIGNAL	POWER	SIGNAL		
45911-0011	POWER	SIGNAL	SIGNAL		
45911-0012	POWER	POWER	SIGNAL	$\frac{3.19}{3.19}$	1.57
45911-0013	SIGNAL	POWER	POWER		
45911-0014	POWER	SIGNAL	POWER		
45911-0015	SIGNAL	SIGNAL	POWER		
45911-0016	SIGNAL	POWER	SIGNAL		
45911-0017	POWER	SIGNAL	SIGNAL		
45911-0018	POWER	POWER	SIGNAL		



EC NO: UCP2008-2498 DRWN: JSCHAFFER 2008/04/16 CHKD: 2008/04/22 APPR: APATEL 2008/04/25	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 1:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
				mm	INCH	DRAWN BY SAMIEC	DATE 2005/04/14	POWER EDGE ASSEMBLY POWER / SIGNAL MIXED VERTICAL SOLDER TAIL MOLEX INCORPORATED	
		4 PLACES	± ---	± ---		CHECKED BY	DATE		
		3 PLACES	± ---	± ---		SAMIEC	2005/04/14		
		2 PLACES	± 0.25	± ---		APPROVED BY	DATE		
		1 PLACE	± 0.25	± ---		MARGULIS	2005/04/14	MOLEX INCORPORATED	
		ANGULAR ±1/2°				MATERIAL NUMBER SEE CHART		DOCUMENT NO. SD-45911-001	SHEET NO. 2 OF 4
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			SIZE A	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			



SEGMENT 1
CIRCUIT 1

SEE CHART ON SHEET 4
FOR MATERIAL NUMBERS



DIM S BETWEEN SIGNAL SEG AND SIGNAL SEG: 5.40
DIM S BETWEEN POWER SEG AND POWER SEG: 2.90
DIM S BETWEEN SIGNAL SEG AND POWER SEG: 4.15

PCB LAYOUT: COMPONENT SIDE



EC NO: UCP2008-2498 DRWN: JSCHAFER 2008/04/16 CHKD: 2008/04/22 APPR: APATEL 2008/04/25 G	DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)			DIMENSION STYLE MM ONLY		SCALE 2:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION	TITLE POWER EDGE ASSEMBLY POWER / SIGNAL MIXED VERTICAL SOLDER TAIL
				mm	INCH	DRAWN BY SAMIEC	DATE 2005/04/14	MOLEX MOLEX INCORPORATED			
			4 PLACES	± ---	± ---	CHECKED BY	DATE				
			3 PLACES	± ---	± ---	SAMIEC	2005/04/14				
			2 PLACES	± 0.25	± ---	APPROVED BY	DATE				
			1 PLACE	± 0.25	± ---	MARGULIS	2005/04/14	DOCUMENT NO. SD-45911-001			
REV			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			MATERIAL NUMBER SEE CHART ON SHEET 4		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			
						SIZE A					

